ES-T2-R

10/100/1000BASE-T Copper SFP Transceiver



PRODUCT FEATURES

- Up to 1.25Gb/s bi-directional data links
- Hot-pluggable SFP footprint
- TX Disable and RX Los/with Los function
- Fully metallic enclosure for low EMI
- Low power dissipation (1.05 W typical)
- Compact RJ-45 connector assembly
- Access to physical layer IC via 2-wire serial bus
- 1000 BASE-T operation in host systems with SERDES interface
- Operating case temperature range of

  0° C to +70° C (Commercial)

APPLICATIONS

- 1.25 Gigabit Ethernet over Cat 5 cable

ETU-LINK

DESCRIPTIONS

ETU-LINK`s ES-T2-R Copper Small Form Pluggable (SFP)transceivers is high performance, cost effective module compliant with the Gigabit Ethernet and 10/100/1000BASE-T standards as specified in IEEE 802. 3-2002 and IEEE 802.3ab, which supp- orting 1000Mbps data- rate up to 100 meters reach over unshielded twisted-pair category 5 cable. The module supports1000 Mbps full duplex data-links with 5-level Pulse Amplitude Modulation (PAM) signals. All four pairs in the cable are used with symbol rate at 250Mbps on each pair. The module provides standard serial ID information compliant with SFP MSA, which can be accessed with address of A0h via the 2wire serial CMOS EEPROM protocol. The physical IC can also be accessed via 2wire serial bus at address A0.

Ordering Information

Part number	Speed mode	MAC interface	TX Disable function	Link Indicator on RX_LOS Pin	Temp
ES-T2-R	10/100/1000 Mbps	SGMII	Yes	Yes	0~70℃

Electrical Power Interface

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply Current	Is		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND
Maximum Voltage	Vmax			4	V	Maximum

Low-speed signals, electronic characteristics

Parameter	Symbol	Min	Max	Units	Notes/Conditions
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Output HIGH	VOH	host_Vcc -0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector
SFP Input HIGH	VIH	2	Vcc +0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector

High-speed electrical interface, transmission line-SFP

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz

High-speed electrical interface, host-SFP

Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Single ended data input swing	Vinswing	250		1200	mV	Single ended
Single ended data output swing	Voutswing	350		800	mV	Single ended
Rise/Fall Time	Tr,Tf		175		psec	20%-80%
Tx Input Impedance	Zin		50		Ohm	Single ended
Rx Output Impedance	Zout		50		Ohm	Single ended

General specifications

Parameter		Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Commercial	Tc	0		70	°C
	Industria		-40		85	°C
Storage Temperature			-40		85	°C

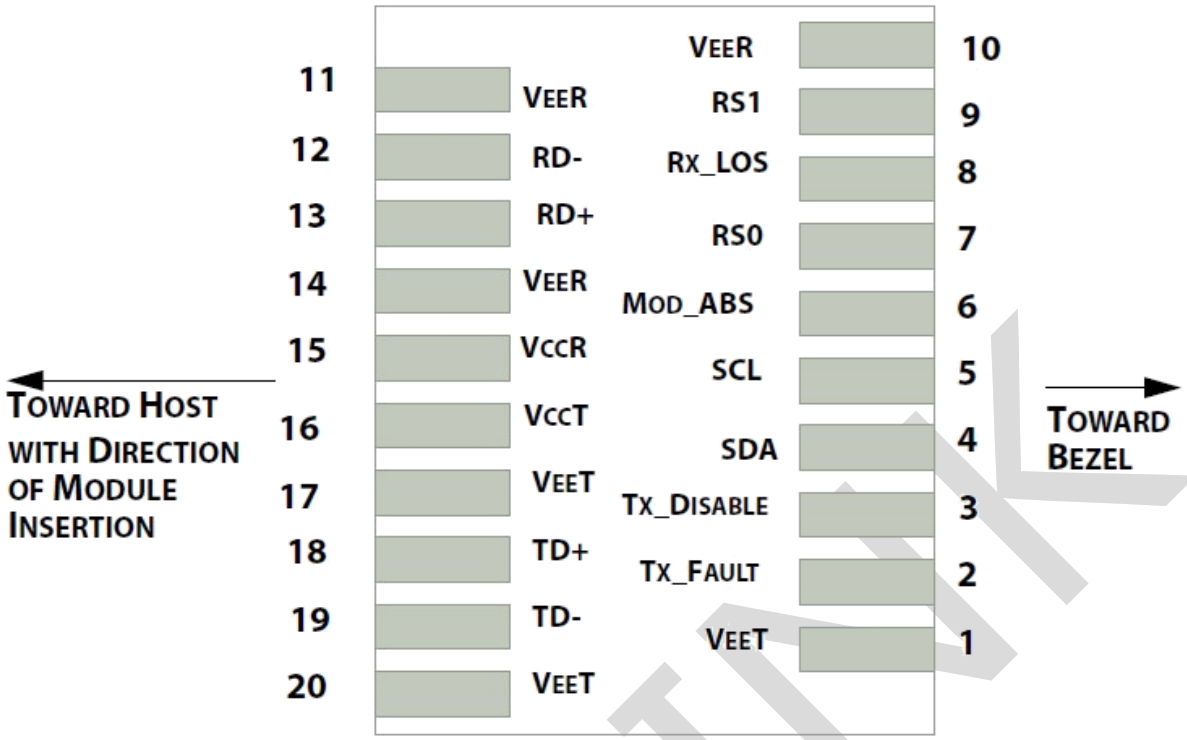
References

1. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA) September 2000.

2. IEEE802.3 – 2002.

3. “AT24C01A/02/04/08/16 2-Wire Serial CMOS E2PROM”, Atmel Corporation.

Pin Definitions



Pin Definitions

PIN	NAME	FUNCTION	SEQ.	NOTES
1	VeeT	Transmitter Ground	1	VeeT and VeeR are connected in SFP.
2	TX_FAULT	Transmitter Fault Indication	3	Not Implemented. Tied to VeeT in SFP.
3	TX_DISABLE	Transmitter Disable	3	See TX Disable.
4	MOD DEF (2)	Module Definition 2	3	Data Line for Serial ID and Bidirectional Data Transfer bus.
5	MOD DEF (1)	Module Definition 1	3	Clock Line for Serial ID and Bidirectional Data Transfer bus.
6	MOD DEF (0)	Module Definition 0	3	Tied to Vee in SFP.
7	RATE SELECT	Not Implemented	3	Not implemented. 33K pulldown to Vee in SFP.
8	LOS	Loss of Signal	3	See LOS option.
9	VeeR	Receiver Ground	1	VeeT and VeeR are connected in SFP.
10	VeeR	Receiver Ground	1	VeeT and VeeR are connected in SFP.
11	VeeR	Receiver Ground	1	VeeT and VeeR are connected in SFP.
12	RD-	Inverted Received Data out	3	AC coupled 100 ohm differential high speed data lines.

13	RD+	Non-Inverted Received Data out	3	AC coupled 100 ohm differential high speed data lines.
14	VeeR	Receiver Ground	1	VeeT and VeeR are connected in SFP.
15	VccR	Receiver Power	2	VccR and VccT are connected in SFP.
16	VccT	Transmitter Power	2	VccR and VccT are connected in SFP.
17	VeeT	Transmitter Ground	1	VeeT and VeeR are connected in SFP.
18	TD+	Non-inverted Data In	3	AC coupled 100 ohm differential high speed data lines.
19	TD-	Inverted Data In	3	AC coupled 100 ohm differential high speed data lines.
20	VeeT	Transmitter Ground	1	VeeT and VeeR are connected in SFP.

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

1) TX Fault is not supported and is always connected to ground.

2) TX disable, an input used to reset the transceiver module, This pin is pulled up within the module with a 4.7 KΩ resistor.

Low (0 – 0.8 V): Transceiver on Between (0.8 V and 2.0 V): Undefined

High (2.0 – 3.465 V): Transceiver in reset state

Open: Transceiver in reset state

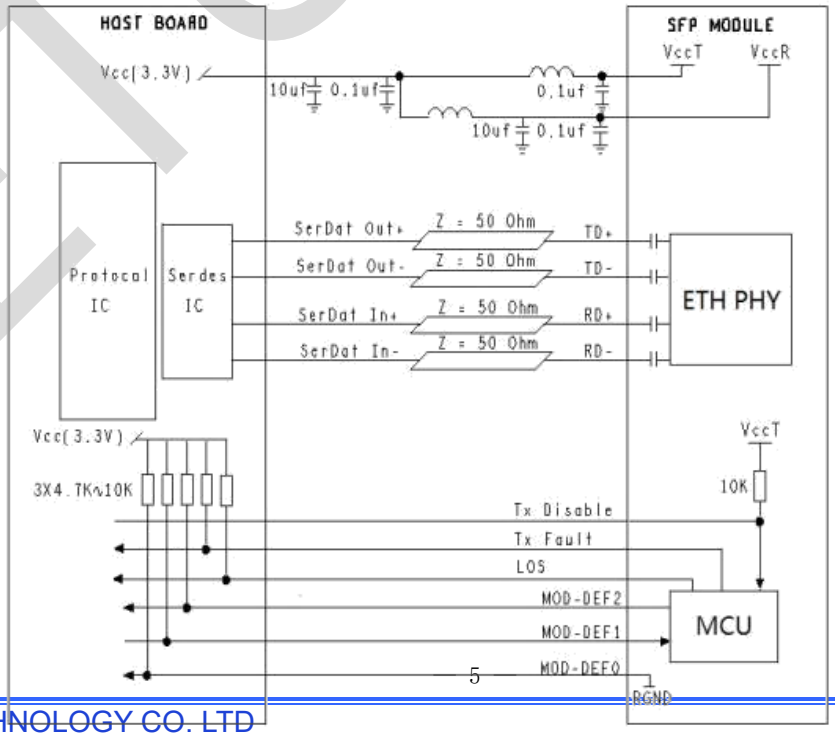
3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K~10K resistor on the host board. The pull-up voltage shall be VccT or VccR

Mod-Def 0 is grounded by the module to indicate that the module is present

Mod-Def 1 is the clock line of two wire serial interface for serial ID

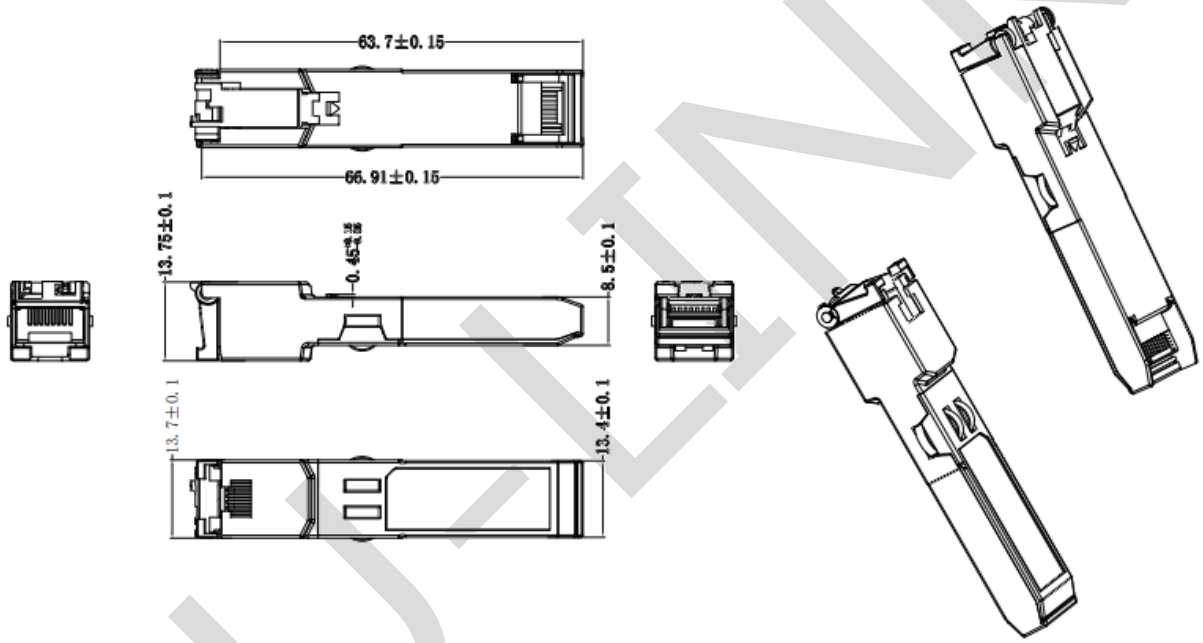
Mod-Def 2 is the data line of two wire serial interface for serial ID

Recommended Interface Circuit

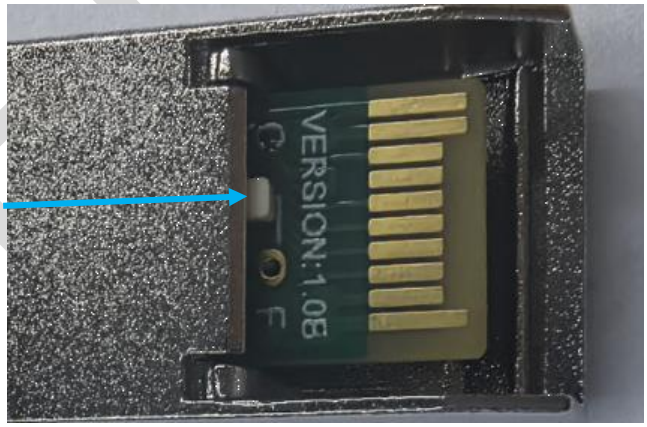


Mechanical Diagram

The host-side of the ES-T2-R conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector



DIP switch control



F: 10/100M 100M Adaptive [100BASE-FX]

C: 10/100/1000M 1000M Adaptive [SGMII/SERDES/100BASE-FX]

Revision History

Version No.	Date	Description
1.0	February 8, 2016	Preliminary datasheet
2.0	October 11,2023	Product upgrades
2.1	July 24, 2024	Format change
2.2	May 21, 2026	Add DIP switch control

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